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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



NX7337BF-AA

Data Sheet

R08DS0003EJ0500

Rev.5.00

Feb 28, 2011

LASER DIODE

1 310 nm InGaAsP MQW-FP LASER DIODE COAXIAL MODULE FOR OTDR APPLICATION

DESCRIPTION

The NX7337BF-AA is a 1 310 nm Multiple Quantum Well (MQW) structured Fabry-Perot (FP) laser diode coaxial module with single mode fiber. This module is specified to operate under pulsed condition and designed for light source of Optical Time Domain Reflectometer (OTDR).

FEATURES

- High output power $P_T = 180 \text{ mW} @ I_{FP} = 1\,000 \text{ mA}^*$
- Long wavelength $\lambda_C = 1\,310 \text{ nm}$

*1 Pulse Conditions: Pulse width (PW) = 10 μs , Duty = 1%

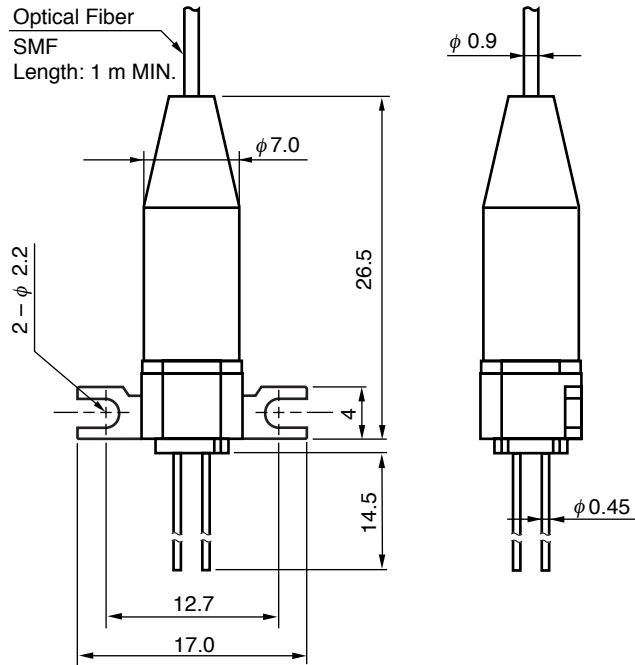


The mark <R> shows major revised points.

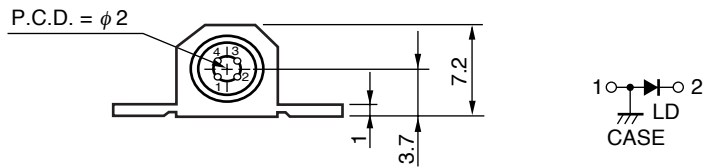
The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

NX7337BF-AA

<R> **PACKAGE DIMENSIONS (UNIT: mm)**



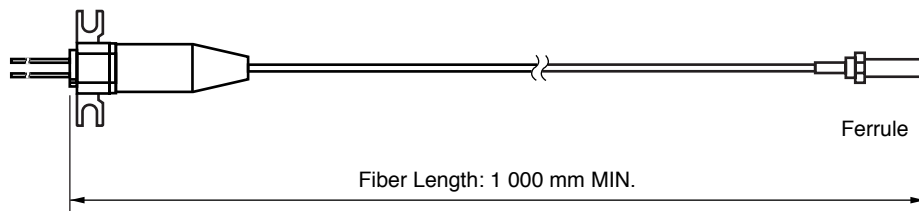
PIN CONNECTIONS



NX7337BF-AA

OPTICAL FIBER CHARACTERISTICS

Parameter	Specification	Unit
Mode Field Diameter	9.3±0.5	μm
Cladding Diameter	125±2	μm
Maximum Cladding Noncircularity	2	%
Maximum Core/Cladding Concentricity	1.6	%
Outer Diameter	0.9±0.1	mm
Cut-off Wavelength	1 140 to 1 280	nm
Minimum Fiber Bending Radius	30	mm
Fiber Length	1 000 MIN.	mm



NX7337BF-AA

ORDERING INFORMATION

Part Number	Flange Type
NX7337BF-AA	flat mount flange

ABSOLUTE MAXIMUM RATINGS (T_c = 25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Pulsed Forward Current ^{*1}	I _{FP}	1.2	A
Reverse Voltage	V _R	2.0	V
Operating Case Temperature	T _C	-20 to +60	°C
Storage Temperature	T _{stg}	-40 to +85	°C
Lead Soldering Temperature	T _{slid}	350 (3 sec.)	°C
Relative Humidity (noncondensing)	RH	85	%

*1 Pulse Condition: Pulse Width (PW) = 10 μs, Duty = 1%

ELECTRO-OPTICAL CHARACTERISTICS (T_c = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward Voltage	V _{FP}	I _{FP} = 1 000 mA, PW = 10 μs, Duty = 1%		2.5	4.0	V
Threshold Current	I _{th}			35	65	mA
Optical Output Power from Fiber	P _f	I _{FP} = 1 000 mA, PW = 10 μs, Duty = 1%	130	180		mW
Center Wavelength	λ _C	RMS (-20 dB), I _{FP} = 1 000 mA, PW = 10 μs, Duty = 1%	1 290	1 310	1 330	nm
Spectral Width	σ	RMS (-20 dB), I _{FP} = 1 000 mA, PW = 10 μs, Duty = 1%		4.5	10.0	nm
Rise Time	t _r	10-90%			2.0	ns
Fall Time	t _f	90-10%			2.0	ns

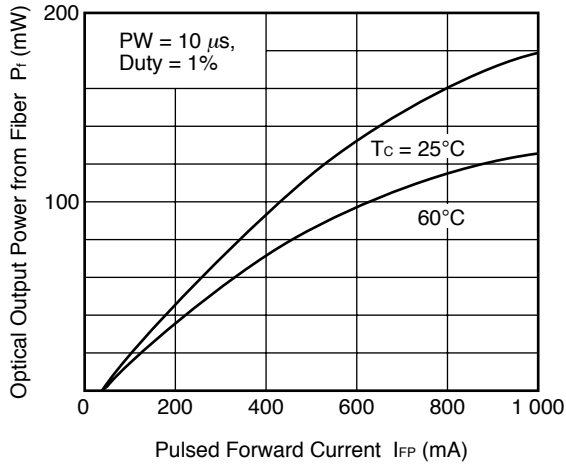
ELECTRO-OPTICAL CHARACTERISTICS (T_c = 0 to +60°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Threshold Current	I _{th}				80	mA
Optical Output Power from Fiber	P _f	I _{FP} = 1000 mA, PW = 10 μs, Duty = 1%	75			mW
Center Wavelength	λ _C	RMS (-20 dB), I _{FP} = 1 000 mA, PW = 10 μs, Duty = 1%	1 280		1 342.5	nm
Temperature Dependency of Center Wavelength	Δλ/ΔT			0.35		nm/°C
Spectral Width	σ	RMS (-20 dB), I _{FP} = 1 000 mA, PW = 10 μs, Duty = 1%			10	nm

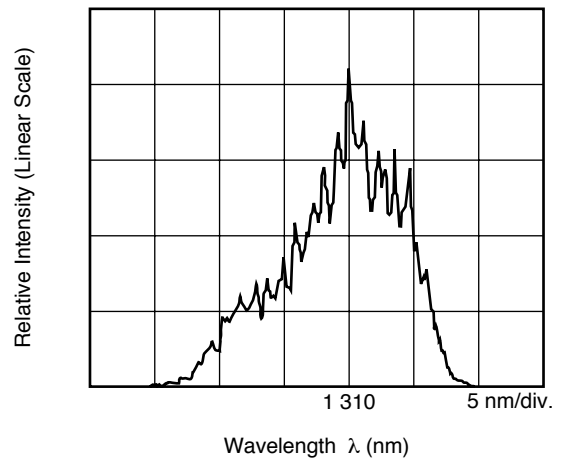
NX7337BF-AA

TYPICAL CHARACTERISTICS (T_c = 25°C, unless otherwise specified)

OPTICAL OUTPUT POWER FROM FIBER vs. PULSED FORWARD CURRENT



SPECTRUM



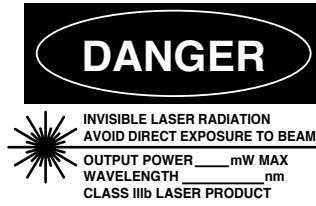
Remark The graphs indicate nominal characteristics.

REFERENCE

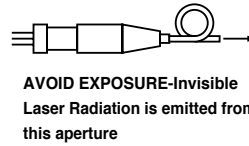
Document Name	Document No.
Opto-Electronics Devices Pamphlet ^{*1}	PX10160E

*1 Published by the former NEC Electronics Corporation.

SAFETY INFORMATION ON THIS PRODUCT



SEMICONDUCTOR LASER



<p>Warning Laser Beam</p>	<p>A laser beam is emitted from this diode during operation. The laser beam, visible or invisible, directly or indirectly, may cause injury to the eye or loss of eyesight.</p> <ul style="list-style-type: none"> • Do not look directly into the laser beam. • Avoid exposure to the laser beam, any reflected or collimated beam.
<p>Caution GaAs Products</p>	<p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"> • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. <ol style="list-style-type: none"> 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.
<p>Caution Optical Fiber</p>	<p>A glass-fiber is attached on the product. Handle with care.</p> <ul style="list-style-type: none"> • When the fiber is broken or damaged, handle carefully to avoid injury from the damaged part or fragments.

Revision History	NX7337BF-AA Data Sheet
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Rev.	Date	Description	
		Page	Summary
-	Jul 2006	-	Previous No. : PL10602EJ03V0DS
4.00	Sep 19, 2010	p.1	Modification of photograph
		p.2, 3	Modification of PACKAGE DIMENSIONS
5.00	Feb 28, 2011	p.2	Modification of PACKAGE DIMENSIONS : MMF -> SMF

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